**Product data sheet** 

## 1. General description

Dual Silicon Carbide Schottky diode in a 3-lead TO247 plastic package, designed for high frequency switched-mode power supplies.





### 2. Features and benefits

- · Extremely fast reverse recovery time
- Low figure of merit (Q<sub>C</sub>\*V<sub>F</sub>)
- · Highly stable switching performance
- Superior in efficiency to Silicon Diode alternatives
- · Reduced losses in associated MOSFET
- Reduced EMI
- · Reduced cooling requirements
- RoHS compliant

## 3. Applications

- · Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

### 4. Quick reference data

### Table 1. Quick reference data

Symbol	Parameter	Conditions	Values			Unit	
Absolute	maximum rating						
$V_{RRM}$	repetitive peak reverse voltage			12	200		V
$I_{O(AV)}$	limiting average forward current	$\delta$ = 0.5; square-wave pulse; T <sub>mb</sub> ≤ 119 °C; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>	30		А		
T <sub>j</sub>	junction temperature		175			°C	
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C; per diode; <u>Fig. 5</u>		-	1.45	1.7	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 150 °C; per diode; <u>Fig. 5</u>		-	1.95	2.3	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 175 °C; per diode; <u>Fig. 5</u>		-	2.1	2.5	V
Dynamic	characteristics	'					
$Q_r$	recovered charge	$I_F = 15 \text{ A}$ ; $dI_F/dt = 500 \text{ A/}\mu\text{s}$ ; $V_R = 400 \text{ V}$ ; $T_i = 25 \text{ °C}$ ; per diode; Fig. 7		-	35	-	nC

# 5. Pinning information

#### Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode		
2	K	cathode		A1
3	A2	anode		K
mb	mb	mounting base; connected to cathode	1 2 3	sym125

## 6. Ordering information

### **Table 3. Ordering information**

Type number	Package	Orderable part number	Packing	Small packing	Small packing Package	
	name		method	quantity	version	issue date
WNSC2D301200CW	TO247	WNSC2D301200CWQ	Tube	30	SOT429	25-Mar-2013

# 7. Marking

## Table 4. Marking codes

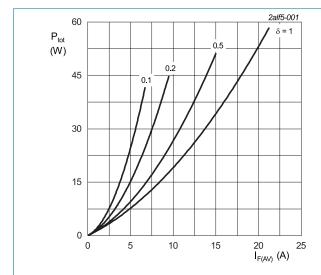
Type number	Marking codes
WNSC2D301200CW	WNSC2D 301200CW

# 8. Limiting values

### **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
$V_{RRM}$	repetitive peak reverse voltage		1200	V
$V_{RWM}$	crest working reverse voltage		1200	V
$V_R$	reverse voltage	DC	1200	V
I <sub>O(AV)</sub>	limiting average forward current	$δ$ = 0.5; square-wave pulse; $T_{mb}$ ≤ 119 °C; both diodes conducting; Fig. 1; Fig. 2; Fig. 3	30	А
I <sub>FRM</sub>	repetitive peak forward current	$δ = 0.5$ ; $t_p = 25 \mu s$ ; $T_{mb} \le 119 °C$ ; square-wave pulse; per diode	30	Α
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	102	А
		$t_p$ = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse; per diode	950	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	sine-wave pulse; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 10 \text{ ms}$	52	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature		-55 to 175	°C
T <sub>j</sub>	junction temperature		175	°C



 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$ V<sub>o</sub> = 1.156 V; R<sub>s</sub> = 0.0750 Ω

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values; per diode

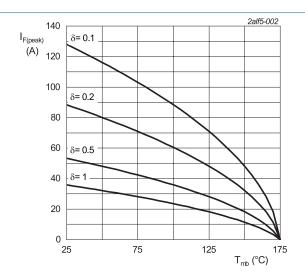
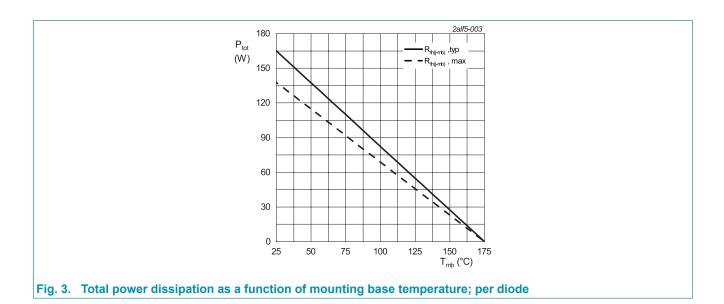


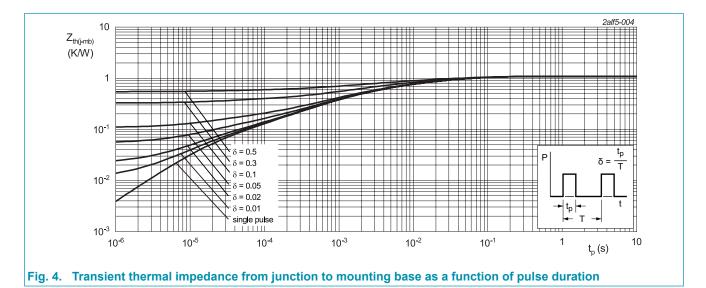
Fig. 2. Current derating as a function of mounting base temperature; per diode



### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

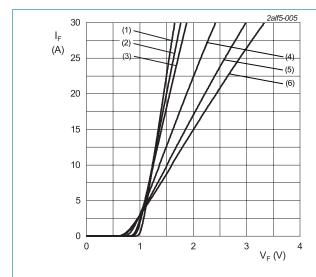
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance	per diode; Fig. 4	-	0.91	1.09	K/W
	from junction to mounting base	both diodes conducting	-	-	0.55	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	in free air	-	40	-	K/W



### 10. Characteristics

#### **Table 7. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	racteristics			J.		
V <sub>F</sub>	forward current	I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C; per diode; <u>Fig. 5</u>	-	1.45	1.7	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 150 °C; per diode; <u>Fig. 5</u>	-	1.95	2.3	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 175 °C; per diode; <u>Fig. 5</u>	-	2.1	2.5	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1200 V; T <sub>j</sub> = 25 °C; per diode; <u>Fig. 6</u>	-	5	150	μΑ
		V <sub>R</sub> = 1200 V; T <sub>j</sub> = 175 °C; per diode; <u>Fig. 6</u>	-	80	-	μΑ
Dynamic	characteristics					
Q <sub>r</sub>	recovered charge	$I_F = 15 \text{ A}$ ; $V_R = 400 \text{ V}$ ; $dI_F/dt = 500 \text{ A/µs}$ ; $T_j = 25 \text{ °C}$ ; per diode; Fig. 7	-	35	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C	-	700	-	pF
		f = 1 MHz; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C	-	65	-	pF
		f = 1 MHz; V <sub>R</sub> = 800 V; T <sub>j</sub> = 25 °C	-	48	-	pF
E <sub>as</sub>	non-repetitive avalanche energy	$I_R$ = 4.7 A; L = 10 mH; $T_{j(init)}$ = 25 °C; per diode	110	-	-	mJ



 $V_o$  = 1.156 V;  $R_s$  = 0.0750  $\Omega$ 

(1)  $T_j = -55$  °C; typical values

(2) T<sub>j</sub> = 0 °C; typical values

(3) T<sub>i</sub> = 25 °C; typical values

(4) T<sub>i</sub> = 100 °C; typical values

(5)  $T_j = 150$  °C; typical values

(6) T<sub>i</sub> = 175 °C; typical values

Fig. 5. Forward current as a function of forward voltage; typical values; per diode

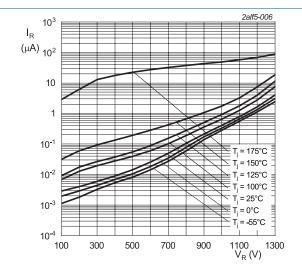
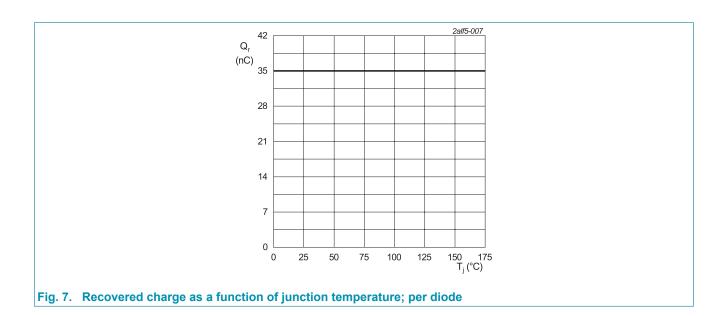
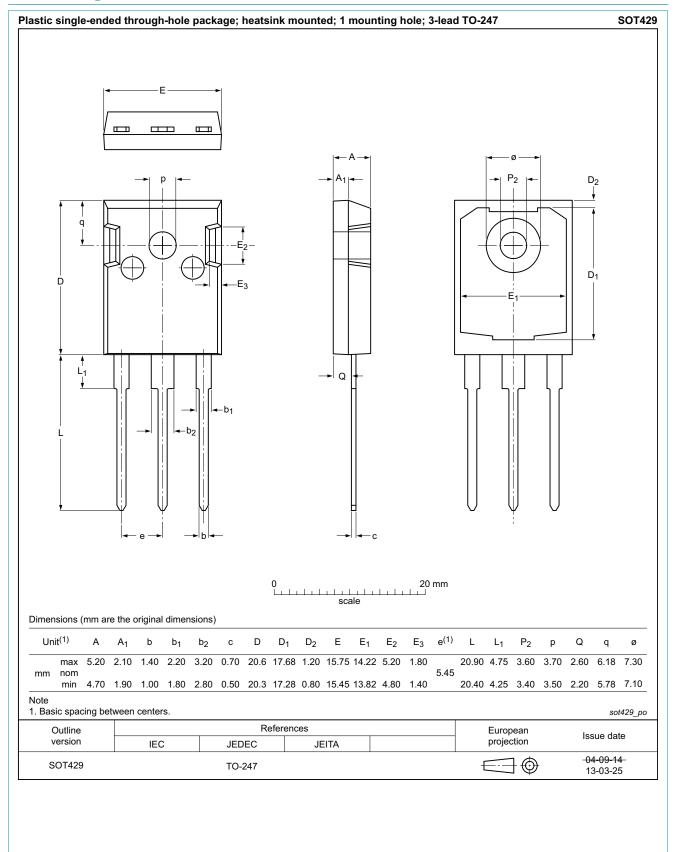


Fig. 6. Reverse leakage current as a function of reverse voltage; typical value; per diode



# 11. Package outline



WNSC2D301200CW

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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